

# **Ordering Information**

Package Type: DFN – 2mm x 2mm – 6L (Halogen Free)

Part Number	Tape and Reel	1 <sup>st</sup> Line Marking	Regulating Current (mA) (Mode 0, MS1 and MS2 connected to pin K)
iML8683NL-C1	iML8683NL-C1-TR	i83C1	40
iML8683NL-C2	iML8683NL-C2-TR	i83C2	66
iML8683NL-C3	iML8683NL-C3-TR	i83C3	52
iML8683NL-D1	iML8683NL-D1-TR	i83D1	80
iML8683NL-D2	iML8683NL-D2-TR	i83D2	130
iML8683NL-D3	iML8683NL-D3-TR	i83D3	104
iML8683NL-ADJ	iML8683NL-ADJ-TR	i83AD	Determined by external resistor only

Package Type: SOT – 89 – 5L (Halogen Free)

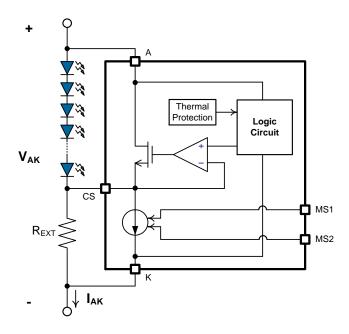
Part Number	Tape and Reel	1 <sup>st</sup> Line Marking	Regulating Current (mA) (Mode 0, MS1 and MS2 connected to pin K)
iML8683BP-C1	iML8683BP-C1-TR	i8683C1	40
iML8683BP-C2	iML8683BP-C2-TR	i8683C2	66
iML8683BP-C3	iML8683BP-C3-TR	i8683C3	52
iML8683BP-D1	iML8683BP-D1-TR	i8683D1	80
iML8683BP-D2	iML8683BP-D2-TR	i8683D2	130
iML8683BP-D3	iML8683BP-D3-TR	i8683D3	104
iML8683BP-ADJ	iML8683BP-ADJ-TR	i8683AD	Determined by external resistor only

#### Dice

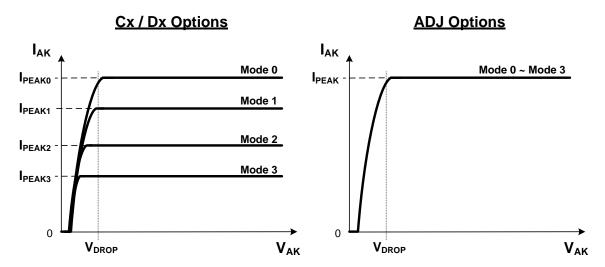
Part Number	Regulating Current (mA) (Mode 0, MS1 and MS2 connected to pin K)
iML8683BZ-C1	40
iML8683BZ-C2	66
iML8683BZ-C3	52
iML8683BZ-D1	80
iML8683BZ-D2	130
iML8683BZ-D3	104
iML8683BZ-ADJ	Determined by external resistor only



# **Block Diagram**



## **I-V Curve**





#### **Pin Descriptions**

Pin Name	Pin I	Number	Pin Function
Pin Name	DFN	SOT-89	Pin Function
CS	1	5	Current sense pin. Connected to negative end of LED string.
Α	3	1	Regulating current input pin. Connected to positive end of LED string.
K	4	2	Regulating current output pin.
MS2	5	3	Mode selection pin 2. Floating or connecting to pin K only.
MS1	6	4	Mode selection pin 1. Floating or connecting to pin K only.
NC	2	1	No Connection
Exposed Thermal Pad		nal Pad	Exposed thermal pad of the chip. Use this pin to enhance the power dissipation ability. The thermal conductivity will be improved if a copper foil on PCB is soldered with the thermal pad. It is recommended to connect the thermal pad to pin K.

#### **Absolute Maximum Ratings**

**Caution**: Values beyond absolute ratings can cause the device to be prematurely damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not guaranteed.

Sustaining Voltage	A to K	-0.3V ~ 88V
Sustaining voltage	CS, MS1, MS2 to K	-0.3V ~ 1V
Regulating Current		150mA
Maximum Operating Junction Temperature, T <sub>J</sub>		165°C
Operating Temperature, T <sub>opr</sub>		-40°C to 110°C
Storage Temperature Range		-55°C to 150°C
Lead Temperature (Soldering, 10 seconds)		260°C

#### Note:

- 1). All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.
- 2). All parameters having Min/Max specifications are guaranteed. Typical values are for reference purpose only. 3). Unless otherwise noted, all tests are pulsed tests at the specified temperature, therefore:  $T_J = T_C = T_A$ .

## **Recommended Operating Conditions**

Parameter	Symbol	Min	Тур	Max	Unit
Regulating Current (with Adequate Heat Sinking) *Note	I <sub>AK</sub>			130	mA
Input Voltage*Note	V <sub>AK</sub>	3		80	V
Maximum Junction Temperature	TJ			150	°C
Operating Free-Air Temperature Range	T <sub>A</sub>	-30		100	°C

Note: Due to thermal dissipation consideration, the maximum LED Vf in parallel should decrease with the regulating current.



#### **Electrical Characteristics**

Unless otherwise noted, typical values are @  $T_A = 25$ °C.

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
			Option C1	38.4	40	41.6	mA
		V <sub>AK</sub> =5V, Mode 0	Option C2	63.4	66	68.6	
Peak Regulating Current			Option C3	49.9	52	54.1	
*Note 1,2	I <sub>PEAK0</sub>	(MS1/ MS2 connected to K)	Option D1	76.8	80	83.2	
			Option D2	124.8	130	135.2	
			Option D3	99.8	104	108.2	
	І <sub>РЕАКО</sub> /І <sub>РЕАКО</sub>	Option C1/C2/C Mode 0, V <sub>AK</sub> =5' (MS1/ MS2 connec	<b>V</b>		100		
Current Ratio of Mode Selection	I <sub>PEAK1</sub> /I <sub>PEAK0</sub>	Option C1/C2/C Mode 1, V <sub>AK</sub> =5' (MS1 open, MS2 c	<b>V</b>	75	80	85	%
*Note 1	I <sub>PEAK2</sub> /I <sub>PEAK0</sub>	Option C1/C2/C3/D1/D2/D3,		50	55	60	. %
	I <sub>PEAK3</sub> /I <sub>PEAK0</sub>	Option C1/C2/C3/D1/D2/D3, Mode 3, V <sub>AK</sub> =5V (MS1/ MS2 open)		32	35	38	
Regulating Current Line	ΔΙ <sub>LR</sub> /Ι <sub>ΡΕΑΚχ</sub>	Option C1/C2/C3/D1/D2/D3, Mode 1~3, V <sub>AK</sub> =5V and 40V			±1	±2	0/
Regulation *Note 3	(x=0~3)	Option C1/C2/C3/D1/D2/D3, Mode 0, V <sub>AK</sub> =5V and 40V		-4	-8	-15	%
CS Pin Voltage	V <sub>CS</sub>	Option ADJ, Mode 0, V <sub>AK</sub> =5V, with 1KΩ external resistor between CS and K		0.26	0.27	0.28	V
CS Pin Voltage Line Regulation*Note 4	ΔV <sub>LR</sub> /V <sub>CS</sub>	Option ADJ, Mode 1~3, V <sub>AK</sub> =5V and 40V with 1KΩ external resistor between CS and K			±1	±2	%
	ΔVLR/VCS	Option ADJ, Mode 0, $V_{AK}$ =5V and 40V with 1K $\Omega$ external resistor between CS and K		-4	-8	-15	%
Dropout Voltage *Note 5	$V_{DROP}$	Mode 0 (MS1/ M	S2 connected to K)		2.8	3.8	V
Thermal Protection Trip Temperature *Note 6	T <sub>TP</sub>	When $T_J$ is higher than $T_{TP}$ , the peak regulating current decreases to $I_{TP}$ linearly.		120	130		°C
Thermal Protection Mode Regulating Current	I <sub>TP</sub> /I <sub>PEAKx</sub> (x=0~3)	T <sub>J</sub> = 175°C			50		%



#### **Three Terminal Current Controller**

Note 1: For ADJ option, the regulating current is determined by an external resistor, R<sub>EXT</sub>, connected between the CS pin and the K pin. The mode selection function will not change the current ratio of option ADJ. To activate the line regulation function, the chip (U3) connected in series with the LED string should be set in Mode 0 (MS1 and MS2 connected to pin K). The regulating current will be:

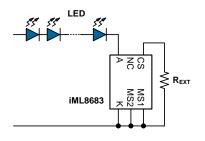
$$I_{PEAK}=0.27/R_{EXT}$$

And the maximum regulating current of second step (ex: U2 in Mode 1) should not exceed 80% of the top level (ex: U3 in Mode 0), otherwise the circuit operation might become abnormal when OTP function is activated. It is strongly recommended to set at 75%.

Note 2: The user can add an external resistor  $R_{\text{EXT}}$  between the CS pin and the K pin of U3 (Mode 0, serial connected to the LED string) to increase the regulating current of option C1, C2, C3, D1, D2 and D3, as shown in below. For U1  $\sim$  U2 (Mode 1  $\sim$  Mode 3, parallel connected to the LED string), adding an external resistor  $R_{\text{EXT}}$  between the CS pin and the K pin may cause abnormal operation and chip damage.

For option C1/ C2/ C3, the regulating current variation  $\Delta I_{PEAK}/I_{PEAK} = 6.25/R_{EXT}$ .

For option D1/ D2/ D3, the regulating current variation  $\Delta I_{PEAK}/I_{PEAK} = 3.13/R_{EXT}$ .



	U3 (Mode 0) regulating current		
	Without external resistor	With 100Ω external resistor	
Option C1	40	42.5	
Option C2	66	70.1	
Option C3	52	55.3	
Option D1	80	82.5	
Option D2	132	136.1	
Option D3	104	107.3	

Note 3: The Regulating Current Line Regulation is defined as:

For Mode 1~3: 
$$\Delta I_{LR}/I_{PEAKx} = \frac{I_{AK(V_{AK}=40V)^*}I_{AK(V_{AK}=5V)}}{I_{AK(V_{AK}=5V)}} \text{ , x=1~-3}$$

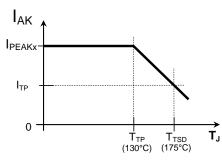
For Mode 0: 
$$\Delta I_{LR}/I_{PEAK0} = \frac{I_{AK(V_{AK}=40V)} I_{AK(V_{AK}=5V)}}{I_{AK(V_{AK}=5V)}}$$

Note 4: The CS Pin Voltage Line Regulation is defined as:

For Mode 1~3: 
$$\Delta V_{LR}/V_{CS} = \frac{V_{CS}(V_{AK}=40V)^{-V}CS(V_{AK}=5V)}{V_{CS}(V_{AK}=5V)}$$

For Mode 0: 
$$\Delta V_{LR}/V_{CS} = \frac{V_{CS}(V_{AK}=40V)^{-}V_{CS}(V_{AK}=5V)}{V_{CS}(V_{AK}=5V)}$$

Note 6: When  $T_J > T_{TP}$ , the peak regulating current decreases linearly to around 50% at 175°C.

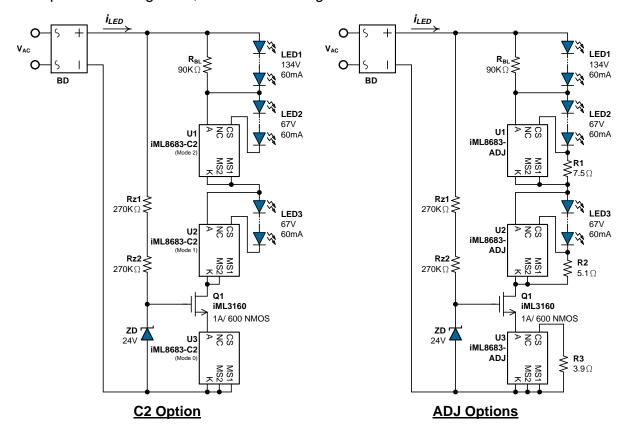




## **Application Circuit**

#### (1) 220V<sub>AC</sub>/ 10W LED Light Engine

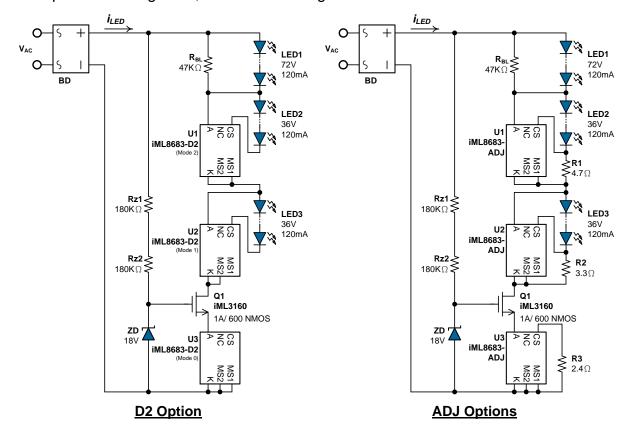
- 3 steps, PF=0.98, THD=16%
- To pass 1KV surge test, Q1 can be changed to 800V NMOS.





### (2) 10W LED Light Engine

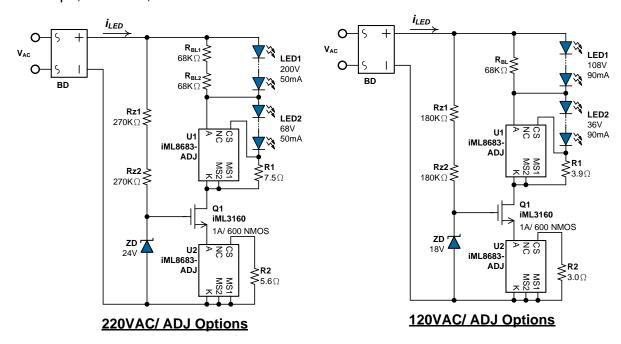
- 3 steps, PF=0.98, THD=16%
- To pass 1KV surge test, Q1 can be changed to 800V NMOS.



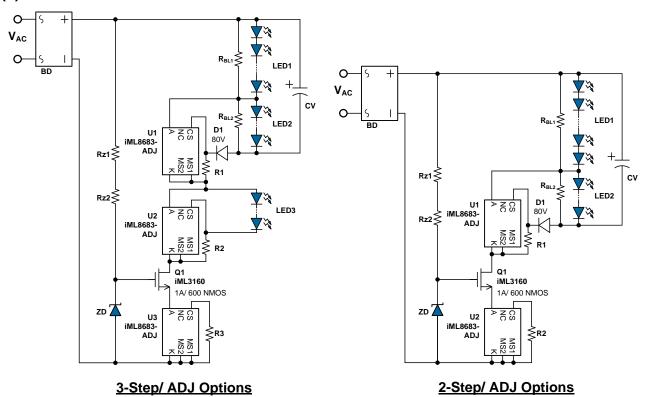


## (3) 7W Low Cost LED Light Engine

- 2 steps, PF=0.95, THD=28%



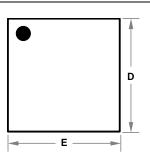
#### (4) Low Flicker Solution

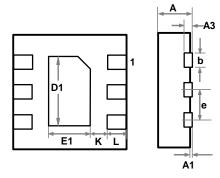




# **Package Information**

#### DFN-2mmx2mm-6L

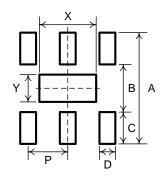




SYMBOLS	MIN.	NOM.	MAX.
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
А3	-	0.20	-
b	0.20	0.30	0.35
D	-	2.00	-
D1	-	1.20	-
Е	-	2.00	-
E1	-	0.70	-
е	-	0.65	-
K	0.20	-	-
L	-	0.30	-

UNIT: MILLIMETERS

#### **Footprint Suggestion**

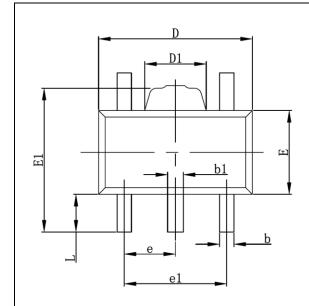


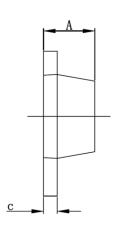
SYMBOLS	Footprint Dimension
А	2.80
В	1.20
С	0.80
D	0.35
Р	0.65
Х	1.40
Y	0.70

 $\theta_{\text{JA}}$ 103 °C / W



#### SOT-89-5L

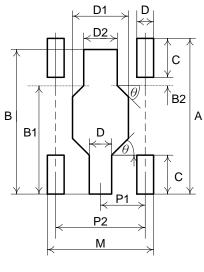




SYMBOLS	MIN.	MAX.
А	1.40	1.60
b	0.32	0.52
b1	0.36	0.56
С	0.35	0.44
D	4.40	4.60
D1	1.40	1.80
E	2.30	2.60
E1	3.94	4.25
е	1.50	TYP
e1	2.90	3.10
L	0.90	1.10
	UNIT: MI	LLIMETERS

UNIT: MILLIMETERS

#### **Footprint Suggestion**



 $\theta_{\text{JA}}$ 127.5 °C / W

SYMBOLS	Footprint Dimension
Α	5.20
В	4.80
B1	3.60
B2	0.25
С	1.35
D	0.70
D1	1.90
D2	1.30
М	3.70
P1	1.50
P2	3.00
θ	45°

UNIT: MILLIMETERS





## **Records of Revisions**

Rev.	Date	Page	Description
1.0	Feb. 7, 2014	All	First release.
1.1	Mar. 6, 2014	1, 2, 3, 11	Remove package types of TO-252.
1.2	Nov. 21, 2014	3	Update the Block Diagram and I-V Curve.
		5, 6	Update the T <sub>TP</sub> Range and Notes.
		7, 8, 9	Update the Application Circuits.
		10, 11	Udate the Package Dimension and Footprint Suggestion.
		12	Add Records of Revision